

**Harvatek Surface Mount CHIP LEDs Data Sheet  
B19H1PT--H9C000214U1930**

Official Product	HT Part No. B19H1PT--H9C000214U1930		
Tentative Product	*****	*****	*****
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1. Life support devices or systems are devices or systems which, (a) are intended for surgical implant into the body, or (b) support or sustain life, and (c) whose failure to perform when properly used in accordance with instructions for use provided in the labeling, can be reasonably expected to result in a significant injury of the user.
2. A critical component in any component of a life support device or system whose failure to perform can be reasonably expected to cause the failure of the life support device or system, or to affect its safety or effectiveness.

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## Product Specifications

Item	Specification	Material	Quantity
Spectral Bandwidth $\lambda_D$	400nm~1100nm @20 mA/ $T_S = 25^\circ\text{C}$		
Peak Sensitivity $\lambda_P$	940nm @20 mA/ $T_S = 25^\circ\text{C}$		
Collector Light Current $I_C$	0.9~2.42mA @ $E_e = 1\text{mW}/\text{cm}^2$ ; $\lambda_P=940\text{nm}$ , $V_{CE}=5\text{V}$		
Resin	Clean	Epoxy	
Carrier tape	EIA 481-1A specs	Conductive black tape	
Reel	EIA 481-1A specs	Conductive black	
Label	HT standard	Paper	
Packing bag	250x230mm	Aluminum laminated bag/ no-zipper	One reel per bag
Carton	HT standard	Paper	Non-specified

### Others:

Each immediate box consists of 5 reels. The 5 reels may not necessarily have the same lot number or the same bin combinations of  $I_V$ , CIE and  $V_f$ . Each reel has a label identifying its specification; the immediate box consists of a product label as well.

Note :This is shipped test conditions

※Remarks: This product should be operated in forward bias. If a reverse voltage is continuously applied to the product, such operation can cause migration resulting in LED damage.

### ATTENTION: Electrostatic Discharge (ESD) protection



The symbol to the left denotes that ESD precaution is needed. ESD protection for GaP and AlGaAs based chips is necessary even though they are relatively safe in the presence of low static-electric discharge. Parts built with AlGaInP, GaN, or/and InGaN based chips are **STATIC SENSITIVE devices**. ESD precaution must be taken during design and assembly.

If manual work or processing is needed, please ensure the device is adequately protected from ESD during the process.

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## Label Specifications



### ■Harvatek P/N:

**B      19H      1      PT--      H9C-      0002      14**

Product	Package	Dice Q' ty	Type	Voltage	Series Number	Taping
PCB	1.6(L)x0.8(W)x0.88(H) mm	1:Single	PT:Phototransistor	5V	X001~XZZZ	1.Taping style 2. Q' ty

### ■ Lot No.:

1	2	3	4	5	6	7	8	9	10
<b>E</b>	<b>1</b>	<b>A</b>	<b>1</b>	<b>A</b>	<b>2</b>	<b>2</b>	<b>L</b>	<b>1</b>	<b>2</b>
Code 1 2		Code 3	Code 4	Code 5	Code 6	Code 7	Code 8	Code 9	Code 10
		Mfg. Year	Mfg. Month	Mfg. Date	Consecutive number		Special code		
Internal Tracing Code		2020-L 2021-M 2022-P 2023-Q ... 2026-T 2027-V ... 2030-Y 2031-Z ...	1:Jan. 2:Feb. ... A:Oct. B:Nov. C:Dec.	1:A 2:B 3:C ... 26:Z 27:7 28:8 29:9 30:3 31:4	01~ZZ		000~ZZZ		

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## Absolute Maximum Rating at 25°C

Symbol	Parameters	Ratings	Units	Notes
$V_{CEO}$	Collector-Emitter Voltage	35	V	
$V_{ECO}$	Emitter-Collector Voltage	5	V	
$I_C$	Collector Current	20	mA	
$T_{opr}$	Operating Temperature	-40 ~ +85	°C	
$T_{stg}$	Storage Temperature	-40 ~ +100	°C	
$T_{sol}$	Soldering Temperature	260	°C	1
$P_{to}$	Total Power Dissipation	150	mW	

### Notes:

- Soldering time  $\leq$  5 seconds.

## Electro-Optical Characteristics

Symbol	Parameters	Test conditions	Min	Typ	Max	Units	Notes
$\lambda_{0.5}$	Range Of Spectral Bandwidth	---	400	-	1100	nm	
$\lambda_P$	Wavelength Of Peak Sensitivity	---	-	940	-	nm	
$BV_{CEO}$	Collector-Emitter Breakdown Voltage	$I_C=100\mu A$ $E_e=0mW/cm^2$	35	-	-	V	
$BV_{ECO}$	Emitter-Collector Breakdown Voltage	$I_E=100\mu A$ $E_e=0mW/cm^2$	5	-	-	V	
$V_{CE(sat)}$	Collector-Emitter Saturation Voltage	$I_C=2mA$ $I_B=100\mu A$	-	-	0.4	V	
$I_{CEO}$	Collector Dark Current	$V_{CE}=20V$ $E_e=0mW/cm^2$	-	-	100	nA	
$I_{C(ON)}$	On State Collector Current	$E_e=1mW/cm^2$ $\lambda_P=940nm, V_{CE}=5V$	0.9	1.2	2.42	mA	2
$t_r$	Rise Time	$V_{CE}=5V, I_C=1mA$ $R_L=1000\Omega$	-	15	-	$\mu S$	3
$t_f$	Fall Time		-	15	-	$\mu S$	

### Notes:

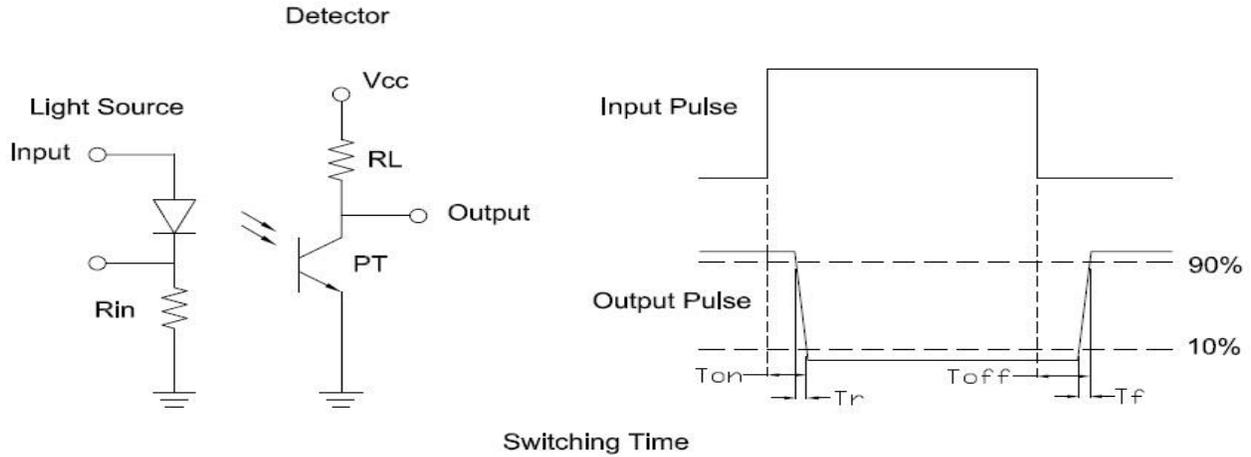
- $I_C$  Bin Rank :

Bin Code	B1	B2	B3
Min	0.9	1.26	1.51
Max	1.54	1.87	2.42

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**Notes:**

3. Test circuit :



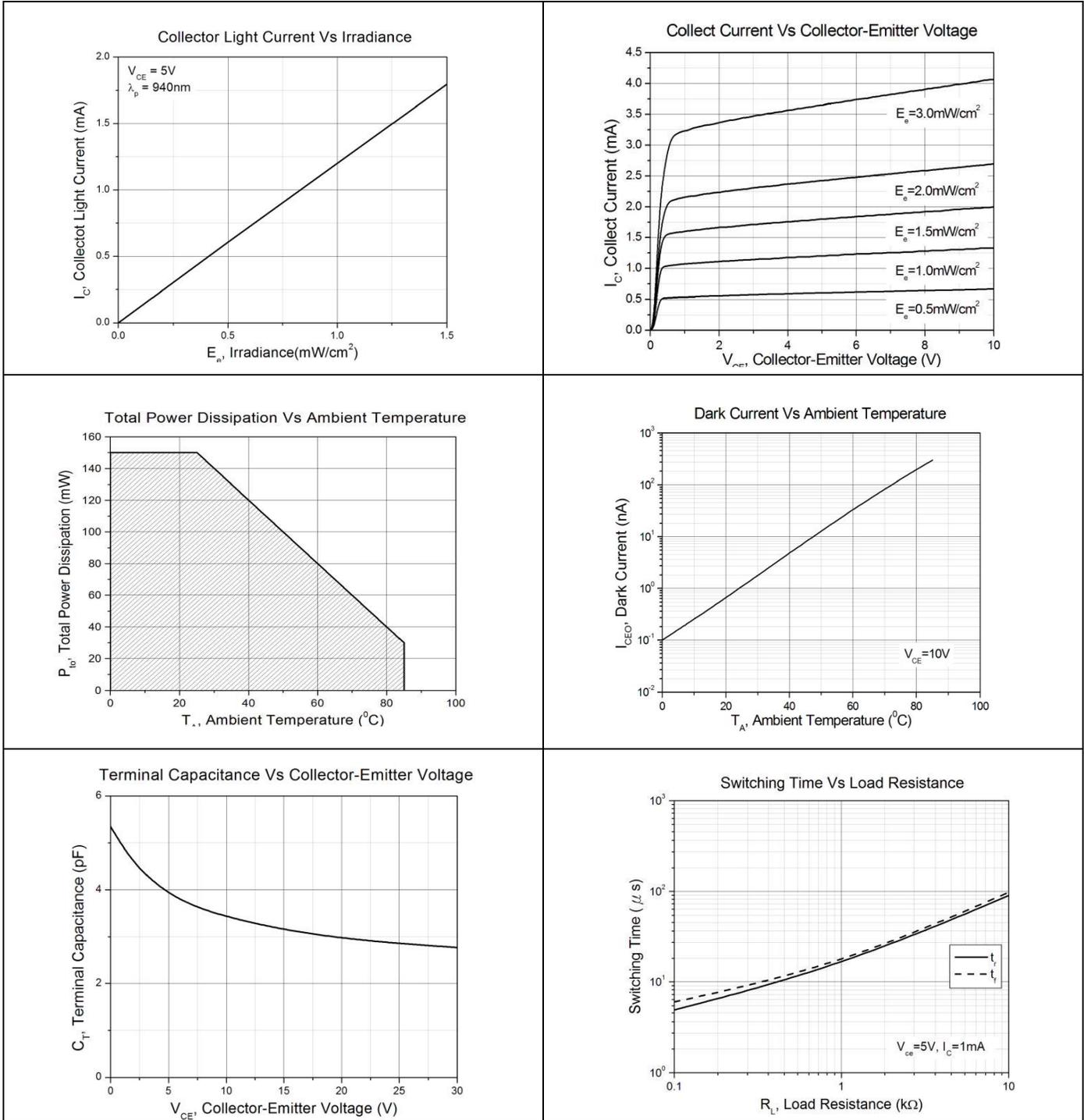
**Package Outline Dimension and Recommended Soldering Pattern for Reflow Soldering**

(Unit: mm Tolerance: +/-0.1)

Outline Dim.	Soldering Pattern
<p>Soldering terminals may shift in the x, y direction.</p>	

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## Characteristics of B19H1PT



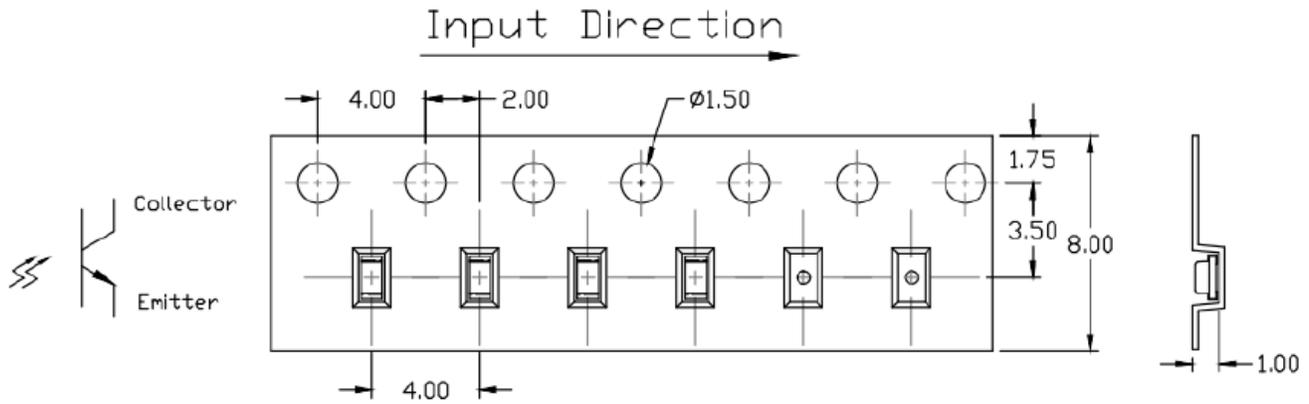
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## Precaution for Use

1. The chips should not be used directly in any type of fluid such as water, oil, organic solvent, etc.
2. When the LEDs are illuminating, the maximum ambient temperature should be first considered before operation.
3. LEDs must be stored in a clean environment. A sealed container with a nitrogen atmosphere is necessary if the storage period is over 3 months after shipping.
4. The LEDs must be used within 4 weeks after unpacked. Unused products must be repacked in an anti-electrostatic package, folded to close any opening and then stored in a dry and cool space.
5. The appearance and specifications of the products may be modified for improvement without further notice.
6. The LEDs are sensitive to the static electricity and surge. It is strongly recommended to use a grounded wrist band and anti-electrostatic glove when handling the LEDs. If a voltage over the absolute maximum rating is applied to LEDs, it will damage LEDs. Damaged LEDs will show some abnormal characteristics such as remarkable increase of leak current, lower turn-on voltage and getting unlit at low current.

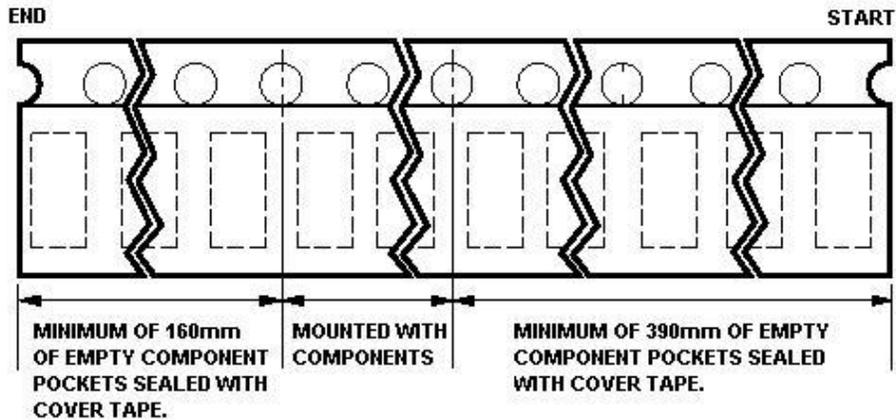
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**Packaging**  
**Tape Dimension**



Dim. A	Dim. B	Dim. C	Q'ty/Reel
1.80±0.05	0.94±0.05	1.0±0.05	4K

Unit: mm



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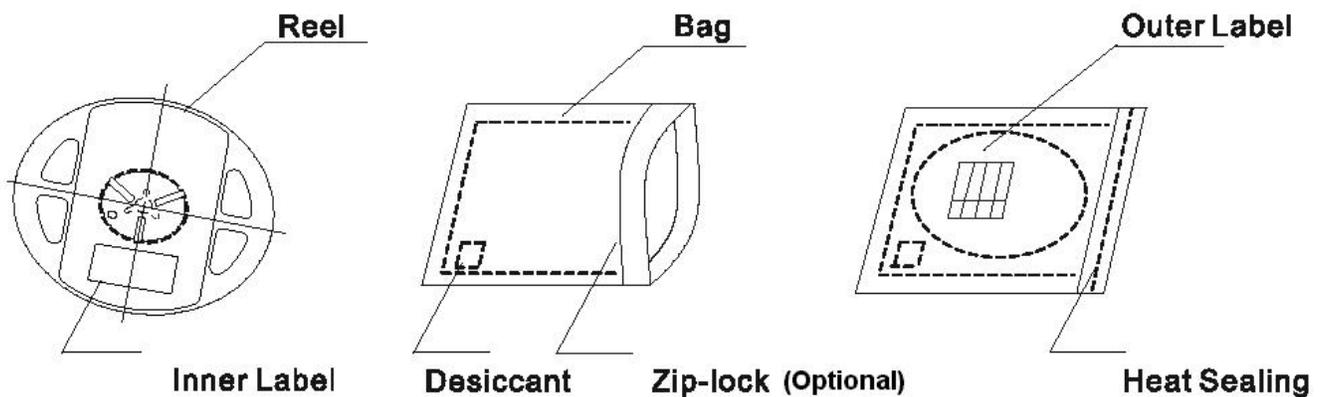


## Dry Pack

All SMD optical devices are **MOISTURE SENSITIVE**. Avoid exposure to moisture at all times during transportation or storage. Every reel is packaged in a moisture protected anti-static bag. Each bag is properly sealed prior to shipment.

A humidity indicator will be included in the moisture protected anti-static bag prior to shipment.

The packaging sequence is as follows:



## Baking

Baking before soldering is recommended when the package has been unsealed for 4 weeks.

The conditions are as followings:

1.  $60\pm 3^{\circ}\text{C} \times (12\sim 24\text{hrs})$  and  $<5\% \text{RH}$ , taped reel type.
2.  $100\pm 3^{\circ}\text{C} \times (45\text{min}\sim 1\text{hr})$ , bulk type.
3.  $130\pm 3^{\circ}\text{C} \times (15\text{min}\sim 30\text{min})$ , bulk type.

## Precautions

1. Avoid exposure to moisture at all times during transportation or storage.
2. Anti-Static precaution must be taken when handling GaN, InGaN, and AlGaInP products.
3. It is suggested to connect the unit with a current limiting resistor of the proper size. Avoid applying a reverse voltage beyond the specified limit.
4. Avoid operation beyond the limits as specified by the absolute maximum ratings.
5. Avoid direct contact with the surface through which the LED emits light.
6. If possible, assemble the unit in a clean room or dust-free environment.

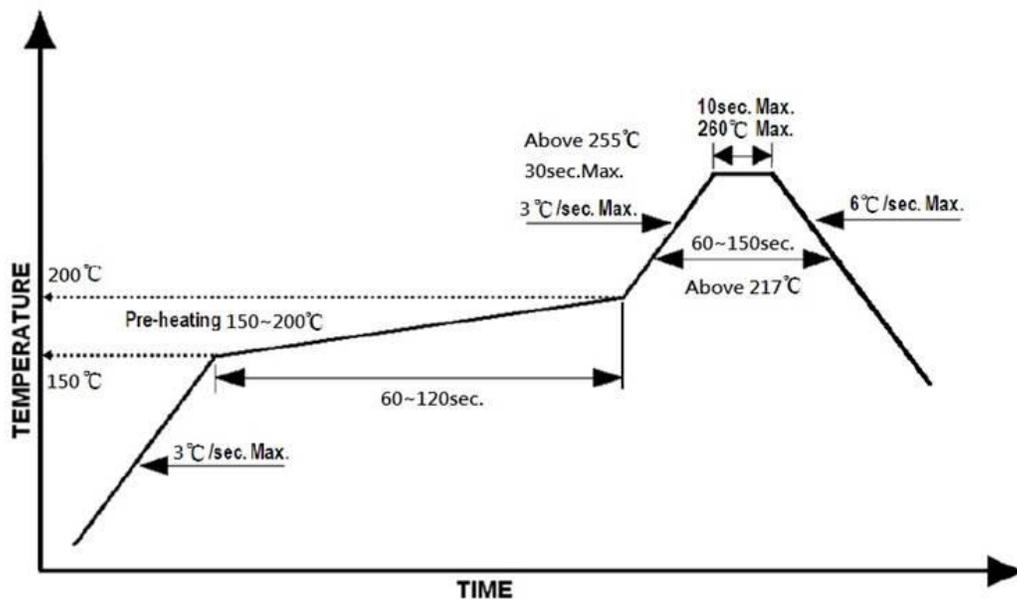
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## Reflow Soldering

Recommend soldering paste specifications:

1. Operating temp.: Above 217°C ,60~150 sec
2. Peak temp.:260°C Max.,10sec Max.
3. Reflow soldering should not be done more than two times.
4. Never take next process until the component is cooled down to room temperature after reflow.
5. The recommended reflow soldering profile (measuring on the surface of the LED terminal) is following:

Lead-free Solder Profile



## Reworking

- Rework should be completed within 5 seconds under 260°C.
- The iron tip must not come in contact with the copper foil.
- Twin-head type is preferred.

## Cleaning

Following are cleaning procedures after soldering:

- An alcohol-based solvent such as isopropyl alcohol (IPA) is recommended.
- Temperature x Time should be 50°C x 30sec. or <30°C x 3min
- Ultra sonic cleaning: < 15W/ bath; bath volume ≤ 1liter
- Curing: 100°C max, <3min

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### Cautions of Pick and Place

- Avoid stress on the resin at elevated temperature.
- Avoid rubbing or scraping the resin by any object.
- Electric-static may cause damage to the component. Please ensure that the equipment is properly grounded. Use of an ionizer fan is recommended.

### Revise History

Rev.	Descriptions	Date	Page
1.0	-	07/28/2017	-
1.1	Change Outline Dim.Picture	10/27/2015	7
1.2	Change title	12/31/2015	1~14
1.3	Remove Wavelength and View Angle	04/08/2016	9~10
2.0	New format	03/03/2017	-
2.1	Packing Update	07/26/2017	11
2.2	$V_{ce(sat)}$ Test conditions	10/05/2017	6
2.3	CHIP LEDs>>>Phototransistor/Revise item name	12/29/2017	1&5
2.4	Update Lot No.	03/03/2020	5
2.5	New Lot No.& Soldering Pattern Pin	08/08/2022	5&7

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